

## DATASHEET

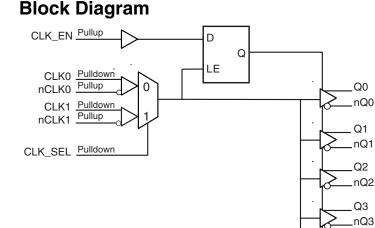
## **General Description**

The ICS85304I-01 is a low skew, high performance 1-to-5 Differential-to-3.3V LVPECL fanout buffer. The ICS85304I-01 has two selectable clock inputs. The CLKx, nCLKx pairs can accept most standard differential input levels. The clock enable is internally synchronized to eliminate runt clock pulses on the outputs during asynchronous assertion/ deassertion of the clock enable pin.

Guaranteed output and part-to-part skew characteristics make the ICS85304I-01 ideal for those applications demanding well defined performance and repeatability.

## **Features**

- Five 3.3V differential LVPECL output pairs
- Selectable differential CLKx, nCLKx input pairs
- $\mathsf{CLKx},$  nCLKx input pairs can accept the following differential levels: LVDS, LVPECL, LVHSTL and HCSL levels •
- ٠ Maximum output frequency: 650MHz
- Translates any single-ended input signal to 3.3V LVPECL levels with resistor bias on nCLKx inputs
- Output skew: 60ps (maximum)
- Part-to-part skew: 300ps (maximum)
- Propagation delay: 2.1ns (maximum)
- Full 3.3V supply mode
- -40°C to 85°C ambient operating temperature
- Lead-free (RoHS 6) package



## **Pin Assignment**

Q0

Q1

Q2

Q3

Q4

nQ4

nQ0

|       |    |    | -       |
|-------|----|----|---------|
| Q0 🗆  | 1  | 20 | Vcc     |
| nQ0□  | 2  | 19 | CLK_EN  |
| Q1    | 3  | 18 | □Vcc    |
| nQ1□  | 4  | 17 | nCLK1   |
| Q2    | 5  | 16 | CLK1    |
| nQ2   | 6  | 15 | VEE     |
| Q3 🗌  | 7  | 14 | nCLK0   |
| nQ3□  | 8  | 13 | CLK0    |
| Q4 🗆  | 9  | 12 | CLK_SEL |
| nQ4 🗌 | 10 | 11 | Vcc     |
|       |    |    |         |

ICS85304I-01

20-Lead TSSOP 6.5mm x 4.4mm x 0.925mm package body G Package **Top View** 

# **Pin Description and Pin Characteristics Tables**

### Table 1. Pin Descriptions

| Number     | Name            | Ту     | ре       | Description   |
|------------|-----------------|--------|----------|---|
| 1, 2       | Q0, nQ0         | Output |          | Differential output pair. LVPECL interface levels.  |
| 3, 4       | Q1, nQ1         | Output |          | Differential output pair. LVPECL interface levels.  |
| 5, 6       | Q2, nQ2         | Output |          | Differential output pair. LVPECL interface levels.  |
| 7, 8       | Q3, nQ3         | Output |          | Differential output pair. LVPECL interface levels.  |
| 9, 10      | Q4, nQ4         | Output |          | Differential output pair. LVPECL interface levels.  |
| 11, 18, 20 | V <sub>CC</sub> | Power  |          | Positive supply pins.   |
| 12         | CLK_SEL         | Input  | Pulldown | Clock select input. When HIGH, selects CLK1, nCLK1 inputs. When LOW, selects CLK0, nCLK0 inputs. LVTTL/LVCMOS interface levels.   |
| 13         | CLK0            | Input  | Pulldown | Non-inverting differential clock input.   |
| 14         | nCLK0           | Input  | Pullup   | Inverting differential clock input.   |
| 15         | V <sub>EE</sub> | Power  |          | Negative supply pin.  |
| 16         | CLK1            | Input  | Pulldown | Non-inverting differential clock input.   |
| 17         | nCLK1           | Input  | Pullup   | Inverting differential clock input.   |
| 19         | CLK_EN          | Input  | Pullup   | Synchronizing clock enable. When HIGH, clock outputs follow clock input.<br>When LOW, Qx outputs are forced LOW, nQx outputs are forced HIGH.<br>LVTTL/LVCMOS interface levels. |

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

#### Table 2. Pin Characteristics

| Symbol                | Parameter               | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------------|-------------------------|-----------------|---------|---------|---------|-------|
| C <sub>IN</sub>       | Input Capacitance       |                 |         | 4       |         | pF    |
| R <sub>PULLDOWN</sub> | Input Pulldown Resistor |                 |         | 51      |         | kΩ    |
| R <sub>PULLUP</sub>   | Input Pullup Resistor   |                 |         | 51      |         | kΩ    |

## **Function Tables**

### Table 3A. Control Input Function Table

| Inputs |         |                        | Outputs       |                |  |
|--------|---------|------------------------|---------------|----------------|--|
| CLK_EN | CLK_SEL | Selected Source Q[0:4] |               | nQ[0:4]        |  |
| 0      | 0       | CLK0, nCLK0            | Disabled; LOW | Disabled; HIGH |  |
| 0      | 1       | CLK1, nCLK1            | Disabled; LOW | Disabled; HIGH |  |
| 1      | 0       | CLK0, nCLK0            | Enabled       | Enabled        |  |
| 1      | 1       | CLK1, nCLK1            | Enabled       | Enabled        |  |

After CLK\_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as shown in Figure 1. In the active mode, the state of the outputs are a function of the CLKx, nCLKx inputs as described in Table 3B.

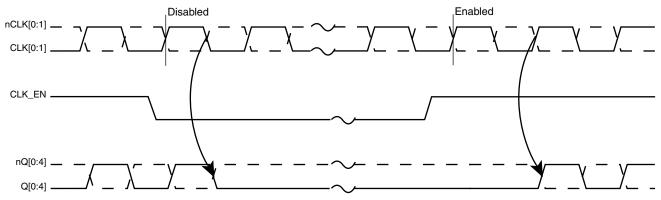


Figure 1. CLK\_EN Timing Diagram

| In             | puts           | Outputs |         |                              |               |
|----------------|----------------|---------|---------|------------------------------|---------------|
| CLK0 or CLK1   | nCLK0 or nCLK1 | Q[0:4]  | nQ[0:4] | Input to Output Mode         | Polarity      |
| 0              | 1              | LOW     | HIGH    | Differential to Differential | Non-Inverting |
| 1              | 0              | HIGH    | LOW     | Differential to Differential | Non-Inverting |
| 0              | Biased; NOTE 1 | LOW     | HIGH    | Single-Ended to Differential | Non-Inverting |
| 1              | Biased; NOTE 1 | HIGH    | LOW     | Single-Ended to Differential | Non-Inverting |
| Biased; NOTE 1 | 0              | HIGH    | LOW     | Single-Ended to Differential | Inverting     |
| Biased; NOTE 1 | 1              | LOW     | HIGH    | Single-Ended to Differential | Inverting     |

Table 3B. Clock Input Function Table

NOTE 1: Please refer to the Application Information section, Wiring the Differential Input to Accept Single-Ended Levels.

# **Absolute Maximum Ratings**

NOTE: Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics or AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

| Item   | Rating                          |
|--|---------------------------------|
| Supply Voltage, V <sub>CC</sub>                                | 4.6V                            |
| Inputs, V <sub>I</sub>   | -0.5V to V <sub>CC</sub> + 0.5V |
| Outputs, I <sub>O</sub><br>Continuous Current<br>Surge Current | 50mA<br>100mA                   |
| Package Thermal Impedance, $\theta_{JA}$                       | 91.1°C/W (0 mps)                |
| Storage Temperature, T <sub>STG</sub>                          | -65°C to 150°C                  |

## **DC Electrical Characteristics**

#### Table 4A. Power Supply DC Characteristics, V\_{CC} = 3.3V $\pm$ 5%, V\_{EE} =0V, T\_A = -40°C to 85°C

| Symbol          | Parameter            | Test Conditions | Minimum | Typical | Maximum | Units |
|-----------------|----------------------|-----------------|---------|---------|---------|-------|
| V <sub>CC</sub> | Core Supply Voltage  |                 | 3.135   | 3.3     | 3.465   | V     |
| I <sub>EE</sub> | Power Supply Current |                 |         |         | 55      | mA    |

### Table 4B. LVCMOS/LVTTL DC Characteristics, $V_{CC} = 3.3V \pm 5\%$ , $V_{EE} = 0V$ , $T_A = -40^{\circ}C$ to $85^{\circ}C$

| Symbol                  | Parameter          |         | Test Conditions                                | Minimum | Typical | Maximum               | Units |
|-------------------------|--------------------|---------|--|---------|---------|-----------------------|-------|
| V <sub>IH</sub>         | Input High Voltage |         |  | 2       |         | V <sub>CC</sub> + 0.3 | V     |
| V <sub>IL</sub>         | Input Low Voltag   | ge      |  | -0.3    |         | 0.8                   | V     |
|                         | Input High         | CLK_EN  | $V_{CC} = V_{IN} = 3.465V$                     |         |         | 5                     | μA    |
| I <sub>IH</sub> Current | Current            | CLK_SEL | $V_{CC} = V_{IN} = 3.465V$                     |         |         | 150                   | μA    |
|                         | Input Low          | CLK_EN  | V <sub>CC</sub> = 3.465V, V <sub>IN</sub> = 0V | -150    |         |                       | μA    |
| IL                      | Current            | CLK_SEL | V <sub>CC</sub> = 3.465V, V <sub>IN</sub> = 0V | -5      |         |                       | μA    |

#### Table 4C. Differential DC Characteristics, $V_{CC} = 3.3V \pm 5\%$ , $V_{EE} = 0V$ , $T_A = -40^{\circ}C$ to $85^{\circ}C$

| Symbol                  | Parameter               |                   | Test Conditions                  | Minimum               | Typical | Maximum                | Units |
|-------------------------|-------------------------|-------------------|----------------------------------|-----------------------|---------|------------------------|-------|
| 1                       | Input High              | nCLK0, nCLK1      | $V_{CC} = V_{IN} = 3.465V$       |                       |         | 5                      | μA    |
| ЧН                      | Current                 | CLK0, CLK1        | $V_{CC} = V_{IN} = 3.465V$       |                       |         | 150                    | μA    |
|                         | Input Low               | nCLK0, nCLK1      | $V_{CC} = 3.465 V, V_{IN} = 0 V$ | -150                  |         |                        | μA    |
| I <sub>IL</sub> Current | Current                 | CLK0, CLK1        | $V_{CC} = 3.465 V, V_{IN} = 0 V$ | -5                    |         |                        | μA    |
| V <sub>PP</sub>         | Peak-to-Peak            | Voltage; NOTE 1   |                                  | 0.15                  |         | 1.3                    | V     |
| V <sub>CMR</sub>        | Common Moc<br>NOTE 1, 2 | le Input Voltage; |                                  | V <sub>EE</sub> + 0.5 |         | V <sub>CC</sub> – 0.85 | V     |

NOTE 1: V<sub>IL</sub> should not be less than -0.3V

NOTE 2: Common mode input voltage is defined as  $V_{IH}$ .

| Symbol             | Parameter                            | Test Conditions | Minimum               | Typical | Maximum               | Units |
|--------------------|--------------------------------------|-----------------|-----------------------|---------|-----------------------|-------|
| V <sub>OH</sub>    | Output High Current; NOTE 1          |                 | V <sub>CC</sub> – 1.4 |         | V <sub>CC</sub> - 0.9 | μA    |
| V <sub>OL</sub>    | Output Low Current; NOTE 1           |                 | V <sub>CC</sub> – 2.1 |         | V <sub>CC</sub> – 1.7 | μA    |
| V <sub>SWING</sub> | Peak-to-Peak Output Voltage<br>Swing |                 | 0.6                   |         | 1.0                   | V     |

#### Table 4D. LVPECL DC Characteristics, $V_{CC} = 3.3V \pm 5\%$ , $V_{EE} = 0V$ , $T_A = -40^{\circ}C$ to $85^{\circ}C$

NOTE 1: Outputs terminated with 50  $\Omega$  to V\_CC – 2V.

## **AC Electrical Characteristics**

Table 5. AC Characteristics,  $V_{CC} = 3.3V \pm 5\%$ ,  $V_{EE} = 0V$ ,  $T_A = -40^{\circ}C$  to  $85^{\circ}C$ 

| Parameter                       | Symbol                       | Test Conditions   | Minimum | Typical | Maximum | Units |
|---------------------------------|------------------------------|-------------------|---------|---------|---------|-------|
| f <sub>OUT</sub>                | Maximum Output Frequency     |                   |         |         | 650     | MHz   |
| t <sub>PD</sub>                 | Propagation Delay; NOTE 1    | <i>f</i> ≤ 650MHz | 1.0     |         | 2.1     | ns    |
| <i>t</i> sk(o)                  | Output Skew; NOTE 2, 3       |                   |         |         | 60      | ps    |
| <i>t</i> sk(pp)                 | Part-to-Part Skew; NOTE 3, 4 |                   |         |         | 300     | ps    |
| t <sub>R</sub> / t <sub>F</sub> | Output Rise/Fall Time        | 20% to 80%        | 300     |         | 700     | ps    |
| odc                             | Output Duty Cycle            |                   | 45      |         | 55      | %     |

NOTE: The device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

NOTE: All parameters measured at 500MHz unless noted otherwise

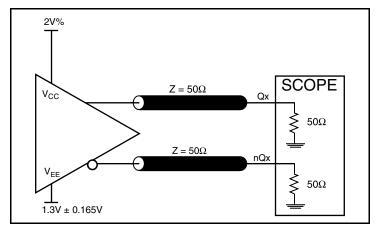
NOTE 1: Measured from the differential input crossing point to the differential output crosspoint.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions. Measured at the output differential crosspoint.

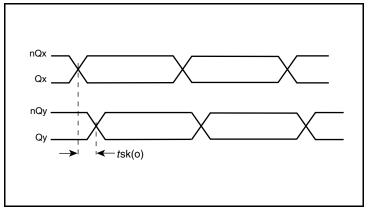
NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

NOTE 4: Defined as skew between outputs on different devices operating at the same supply voltage, same temperature, same frequency and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential crosspoint.

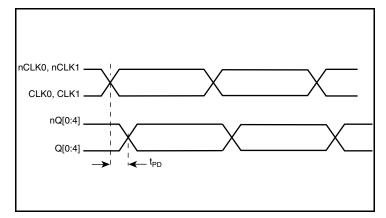
## **Parameter Measurement Information**



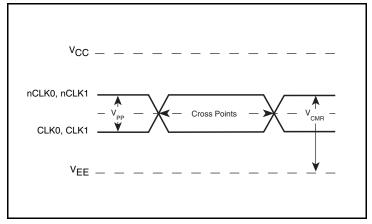
3.3V Output Load AC Test Circuit



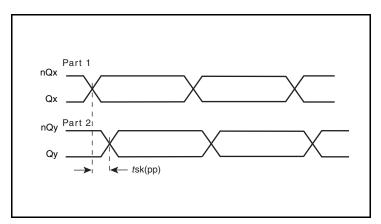
**Output Skew** 



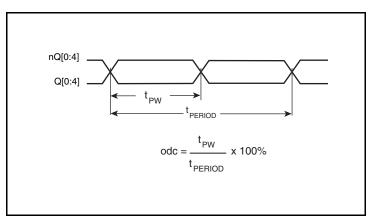
**Propagation Delay** 



### **Differential Input Level**



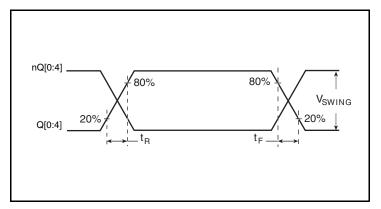
Part-to-Part Skew



**Output Duty Cycle/Pulse Width/Period** 

# RENESAS

# Parameter Measurement Information, continued



**Output Rise/Fall Time** 

# **Applications Information**

# Wiring the Differential Input to Accept Single-Ended Levels

*Figure 2* shows how a differential input can be wired to accept single ended levels. The reference voltage  $V_1 = V_{CC}/2$  is generated by the bias resistors R1 and R2. The bypass capacitor (C1) is used to help filter noise on the DC bias. This bias circuit should be located as close to the input pin as possible. The ratio of R1 and R2 might need to be adjusted to position the V<sub>1</sub> in the center of the input voltage swing. For example, if the input clock swing is 2.5V and V<sub>CC</sub> = 3.3V, R1 and R2 value should be adjusted to set V<sub>1</sub> at 1.25V. The values below are for when both the single ended swing and V<sub>CC</sub> are at the same voltage. This configuration requires that the sum of the output impedance of the driver (Ro) and the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the input will attenuate the signal in half. This can be done in one of two ways. First, R3 and R4 in parallel should equal the transmission line

impedance. For most 50 $\Omega$  applications, R3 and R4 can be 100 $\Omega$ . The values of the resistors can be increased to reduce the loading for slower and weaker LVCMOS driver. When using single-ended signaling, the noise rejection benefits of differential signaling are reduced. Even though the differential input can handle full rail LVCMOS signaling, it is recommended that the amplitude be reduced. The datasheet specifies a lower differential amplitude, however this only applies to differential signals. For single-ended applications, the swing can be larger, however V<sub>IL</sub> cannot be less than -0.3V and V<sub>IH</sub> cannot be more than V<sub>CC</sub> + 0.3V. Though some of the recommended components might not be used, the pads should be placed in the layout. They can be utilized for debugging purposes. The datasheet specifications are characterized and guaranteed by using a differential signal.

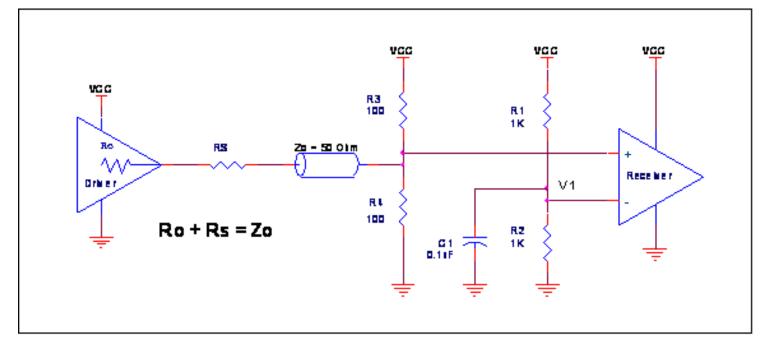


Figure 2. Recommended Schematic for Wiring a Differential Input to Accept Single-ended Levels

## **Differential Clock Input Interface**

The CLK /nCLK accepts LVDS, LVPECL, LVHSTL, HCSL and other differential signals. Both  $V_{SWING}$  and  $V_{OH}$  must meet the  $V_{PP}$  and  $V_{CMR}$  input requirements. *Figures 3A to 3E* show interface examples for the CLK /nCLK input driven by the most common driver types. The input interfaces suggested here are examples only. Please consult

with the vendor of the driver component to confirm the driver termination requirements. For example, in Figure 3A, the input termination applies for IDT open emitter LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

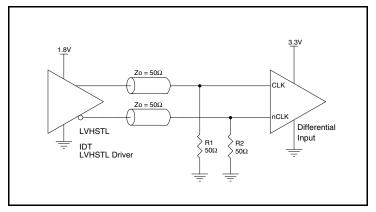


Figure 3A. CLK/nCLK Input Driven by an IDT Open Emitter LVHSTL Driver

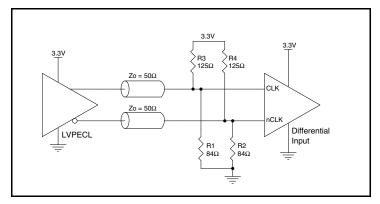


Figure 3C. CLK/nCLK Input Driven by a 3.3V LVPECL Driver

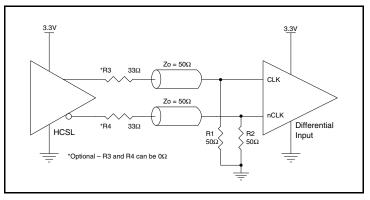


Figure 3E. CLK/nCLK Input Driven by a 3.3V HCSL Driver

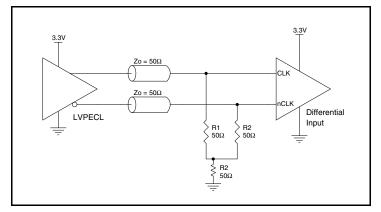


Figure 3B. CLK/nCLK Input Driven by a 3.3V LVPECL Driver

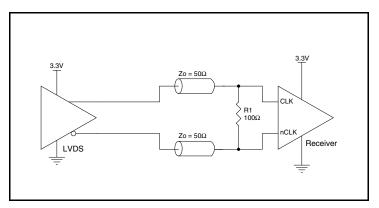


Figure 3D. CLK/nCLK Input Driven by a 3.3V LVDS Driver

### **Recommendations for Unused Input and Output Pins**

#### Inputs:

#### **LVCMOS Control Pins**

All control pins have internal pullup or pulldown resistors; additional resistance is not required but can be added for additional protection. A  $1k\Omega$  resistor can be used.

### CLK/nCLK Inputs

For applications not requiring the use of the differential input, both CLK and nCLK can be left floating. Though not required, but for additional protection, a  $1k\Omega$  resistor can be tied from CLK to ground.

### **Outputs:**

### **LVPECL Outputs**

All unused LVPECL output pairs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

## Termination for 3.3V LVPECL Outputs

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

The differential outputs are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive  $50\Omega$ 

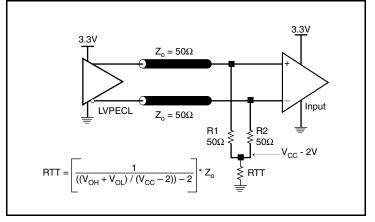


Figure 4A. 3.3V LVPECL Output Termination

transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 4A and 4B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

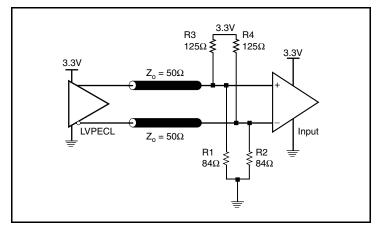


Figure 4B. 3.3V LVPECL Output Termination



## **Power Considerations**

This section provides information on power dissipation and junction temperature for the ICS85304I-01. Equations and example calculations are also provided.

#### 1. Power Dissipation.

The total power dissipation for the ICS85304I-01 is the sum of the core power plus the power dissipated due to the load. The following is the power dissipation for  $V_{CC} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated due to the load.

- Power (core)<sub>MAX</sub> = V<sub>CC MAX</sub> \* I<sub>EE MAX</sub> = 3.465V \* 55mA = 190.575mW
- Power (outputs)<sub>MAX</sub> = 30mW/Loaded Output pair
   If all outputs are loaded, the total power is 5 \* 30mW = 150mW

Total Power\_MAX (3.465V, with all outputs switching) = 190.575mW + 150mW = 340.575mW

#### 2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS devices is 125°C.

The equation for Tj is as follows: Tj =  $\theta_{JA}$  \* Pd\_total + T<sub>A</sub>

Tj = Junction Temperature

 $\theta_{JA}$  = Junction-to-Ambient Thermal Resistance

Pd\_total = Total Device Power Dissipation (example calculation is in section 1 above)

T<sub>A</sub> = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 91.1°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:

 $85^{\circ}C + 0.341W * 91.1^{\circ}C/W = 116.06^{\circ}C$ . This is below the limit of  $125^{\circ}C$ .

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow and the type of board (multi-layer).

#### Table 6. Thermal Resistance $\theta_{JA}$ for 20 Lead TSSOP, Forced Convection

| $\theta_{JA}$ by Velocity                   |          |          |          |  |  |
|---|----------|----------|----------|--|--|
| Meters per Second                           | 0        | 1        | 2.5      |  |  |
| Multi-Layer PCB, JEDEC Standard Test Boards | 91.1°C/W | 86.7°C/W | 84.6°C/W |  |  |

#### 3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load. LVPECL output driver circuit and termination are shown in *Figure 5.* 

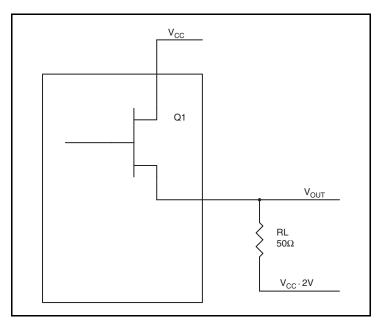


Figure 5. LVPECL Driver Circuit and Termination

To calculate power dissipation due to the load, use the following equations which assume a 50 $\Omega$  load, and a termination voltage of V<sub>CC</sub> – 2V.

- For logic high,  $V_{OUT} = V_{OH\_MAX} = V_{CC\_MAX} 0.9V$ ( $V_{CC\_MAX} - V_{OH\_MAX}$ ) = 0.9V
- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CO\_MAX} 1.7V$ ( $V_{CC\_MAX} - V_{OL\_MAX}$ ) = 1.7V

Pd\_H is power dissipation when the output drives high.

Pd\_L is the power dissipation when the output drives low.

 $\begin{array}{l} \mathsf{Pd}_{-}\mathsf{H} = [(\mathsf{V}_{\mathsf{OH}\_\mathsf{MAX}} - (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - 2\mathsf{V}))/\mathsf{R}_{\mathsf{L}}] * (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OH}\_\mathsf{MAX}}) = [(2\mathsf{V} - (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OH}\_\mathsf{MAX}}))/\mathsf{R}_{\mathsf{L}}] * (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OH}\_\mathsf{MAX}}) = [(2\mathsf{V} - 0.9\mathsf{V})/50\Omega] * 0.9\mathsf{V} = 19.8\mathsf{mW} \end{array}$ 

 $\begin{array}{l} \mathsf{Pd}_{-}\mathsf{L} = [(\mathsf{V}_{\mathsf{OL}\_\mathsf{MAX}} - (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - 2\mathsf{V}))/\mathsf{R}_{\mathsf{L}}] * (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OL}\_\mathsf{MAX}}) = [(2\mathsf{V} - (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OL}\_\mathsf{MAX}}))/\mathsf{R}_{\mathsf{L}}] * (\mathsf{V}_{\mathsf{CC}\_\mathsf{MAX}} - \mathsf{V}_{\mathsf{OL}\_\mathsf{MAX}}) = [(2\mathsf{V} - 1.7\mathsf{V})/50\Omega] * 1.7\mathsf{V} = 10.2\mathsf{mW} \end{array}$ 

Total Power Dissipation per output pair = Pd\_H + Pd\_L = **30mW** 

## **Reliability Information**

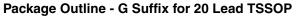
Table 7.  $\theta_{\text{JA}}$  vs. Air Flow Table for a 20 Lead TSSOP

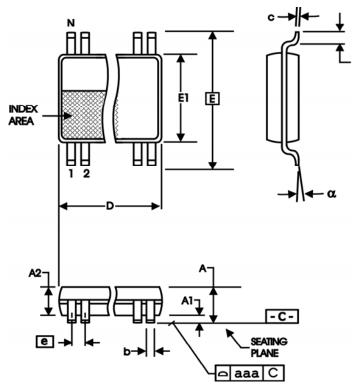
| θ <sub>JA</sub> by Velocity                 |          |          |          |  |  |
|---|----------|----------|----------|--|--|
| Meters per Second                           | 0        | 1        | 2.5      |  |  |
| Multi-Layer PCB, JEDEC Standard Test Boards | 91.1°C/W | 86.7°C/W | 84.6°C/W |  |  |

### **Transistor Count**

The transistor count for ICS85304I-01 is: 489

# Package Outline and Package Dimensions





#### Table 8. Package Dimensions

| All Dimensions in Millimeters |            |            |  |  |  |
|-------------------------------|------------|------------|--|--|--|
| Symbol                        | Minimum    | Maximum    |  |  |  |
| N                             | 20         |            |  |  |  |
| Α                             |            | 1.20       |  |  |  |
| A1                            | 0.05       | 0.15       |  |  |  |
| A2                            | 0.80       | 1.05       |  |  |  |
| b                             | 0.19       | 0.30       |  |  |  |
| C                             | 0.09       | 0.20       |  |  |  |
| D                             | 6.40       | 6.60       |  |  |  |
| E                             | 6.40       | 6.40 Basic |  |  |  |
| E1                            | 4.30       | 4.50       |  |  |  |
| е                             | 0.65 Basic |            |  |  |  |
| L                             | 0.45       | 0.75       |  |  |  |
| α                             | 0°         | 8°         |  |  |  |
| aaa                           |            | 0.10       |  |  |  |

Reference Document: JEDEC Publication 95, MO-153



# **Ordering Information**

### Table 9. Ordering Information

| Part/Order Number | Marking      | Package                   | Shipping Packaging | Temperature   |
|-------------------|--------------|---------------------------|--------------------|---------------|
| 85304AGI-01LF     | ICS85304AI01 | "Lead-Free" 20 Lead TSSOP | Tube               | -40°C to 85°C |
| 85304AGI-01LFT    | ICS85304AI01 | "Lead-Free" 20 Lead TSSOP | Tape & Reel        | -40°C to 85°C |



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